

100V, Synchronous PWM Buck Controller

1 Features

- 12V to 100V wide operating input range
- Adjustable Frequency from 50kHz to 500kHz Operation
- Precision Reference Voltage (1.2 V)
- Programmable Soft-Start with Pre-biased Load Capability
- Programmable EN Off Delay Function
- Programmable Over-Load Protection with 0.2s blank timer and Hiccup
- Programmable Cycle-by-Cycle Current Limiting Protection
- Programmable Input Under-Voltage Lockout Protection with Latch
- Programmable Input Over-Voltage Protection with
 Latch
- Output Over-Voltage Protection
- Over-Temperature Protection
- ETSSOP20 packages

3 Description

PL59011 is a high voltage PWM controller designed for high performance synchronous Buck DC/DC applications with input voltages up to 100V.

PL59011 drives a pair of external N – MOSFETs. The switching frequency is programmable from 50 kHz up to 500 kHz allowing the flexibility to tune for efficiency and size. The output voltage can be precisely regulated using the internally 1.2 V reference voltage for low voltage applications.

Protection features include user programmable under voltage lockout, over voltage lockout and over current protection. The supply current drops below 10µA in shutdown mode. PL59011 is a good choice for car infotainment application, telecom bus converter, etc.

2 Applications

- 48 V Non-Isolated DC-DC Converter
- Car applications
- Telecom Bus Converters
- General purpose
- USB Type-C Power Delivery
- Industrial DC-DC Motor Drivers

4 Typical Application Schematic

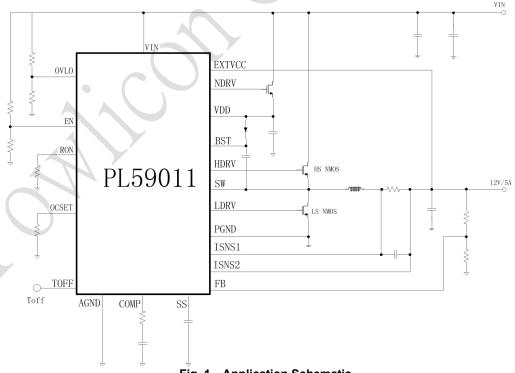


Fig. 1 Application Schematic



5 Pin Configuration and Functions

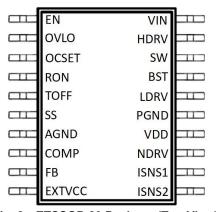


Fig. 2 ETSSOP-20 Package (Top View)

		A		
	Pin	Description		
Number	Name	Description		
1	EN	Enable pin.		
2	OVLO	An external voltage divider is used to set the over voltage threshold levels.		
3	OCSET	Current limit set point. A resistor from this pin to GND will set the positive and negative current limit threshold.		
4	RON	Connect this pin to GND by a resistor to set the switching frequency.		
5	TOFF	This pin provides user programmable shutdown delay time function. Connect to GND: No Delay Connect to VCC: 20s Floating: 10s		
6	SS	This pin provides user programmable soft-start function. External capacitor connected from this pin to ground sets the startup time of the output voltage.		
7	AGND	Signal ground for internal reference and control circuitry.		
8	COMP	Output of error amplifier. An external resistor and capacitor network is typically connected from this pin to ground to provide loop compensation.		
9	FB	Feedback Input. FB senses the output voltage. Connect FB with a resistor divider connected between the output and ground. FB is a sensitive node. Keep FB away from noisy signal, such as SW and BST pin.		
10 EXTVCC		External Power Input to an Internal LDO linear regulator Connected to VCC. This LDO supplies VCC power from EXTVCC, bypassing the external NDRV LDO whenever EXTVCC is higher than 10V. Do not exceed 30V on this pin. Do not connect EXTVCC to a voltage greater than VIN. Connect to GND if not used.		
11	ISNS2	Inductor current sense input 2.		
12	ISNS1 🗸	Inductor current sense input 1.		
13	NDRV	Drive Output for External Pass Device of the NDRV LDO Linear Regulator for VCC. Connect this pin to the gate of an external NMOS pass device.		
14	VDD	This pin provides power for the internal blocks of the IC. A minimum of 4.7uFcapacitor must be connected from this pin to ground.		
15	PGND	Power Ground. This pin serves as a separate ground for the MOSFET driver and should be connected to the system's power ground plane.		
16	LDRV	Output driver for low side MOSFET.		
17	BST	This pin powers the high side driver and must be connected to a voltage higher than input voltage. A minimum of 0.1uF, high frequency capacitor must be connected from this pin to switch node.		
18	SW	Switch Node. This pin is connected to the source of the upper MOSFET and the drain of the lower MOSFET. This pin is return path for the upper gate driver.		
19	HDRV	Output driver for high side MOSFET.		
20	VIN	Input voltage.		



6 Device Marking Information

Order Information	Label Part NO.	Package	Package Qty	Top Marking
PL59011	PL59011IET20A	ETSSOP-20 4000	4000	59011
1 200011	I LOSOTTIL IZOA		4000	RAAYMD

PL59011: Part Number

RAAYMD: RAA: LOT NO.; YMD: Package Date Code



7 Specifications

7.1 Absolute Maximum Ratings(Note1)

	PARAMETER	MIN	MAX	Unit
	V _{IN} to GND	-0.3	100	
	V _{FB} , V _{OVLO} , V _{UVLO} to GND	-0.3	6	
Innut \/altagaa	V _{TOFF} to GND	-0.3	12	V
Input Voltages	V _{ISNS1,2} to GND	-0.3	65	V
	V _{EN} to GND	-0.3	100	
	V _{EXTVCC} to GND	-0.3	30	
	V _{VDD} to GND	-0.3	12	
	V _{RON} , V _{OCSET} , V _{SS} , V _{COMP} to GND	-0.3	6	
Output Voltages	V _{LDRV} to GND	-0.3	12	v
Output voitages	V _{HDRV} to V _{SW}	-0.3	12	\ \ \
	V _{BST} to V _{SW}	-0.3	12	
	V _{SW} to GND	-3	V _{IN} + 0.3	

7.2 Handling Ratings

PARAMETER	DEFINITION	MIN	MAX	UNIT
T _{ST}	Storage Temperature Range	-65	150	°C
T _J Junction Temperature			+150	°C
T _L Lead Temperature			+260	°C
,,	HBM Human body model		2	kV
V _{ESD}	CDM Charger device model		500	V

7.3 Recommended Operating Conditions (Note 2)

	PARAMETER	MIN	MAX	Unit	
	V _{IN} to GND	12	100		
	V _{FB} , V _{OVLO} , V _{UVLO} to GND	-0.3	5		
Input Voltages	V _{TOFF} to GND	-0.3	10	V	
Input Voltages	V _{ISNS1,2} to GND	-0.3	60	V	
	V _{EN} to GND	-0.3	-0.3 100		
	V _{EXTVCC} to GND	-0.3	30		
	V _{VDD} to GND	-0.3	10		
	V _{RON} , V _{OCSET} , V _{SS} , V _{COMP} to GND	-0.3	5		
Output Valtages	V _{LDRV} to GND -0.3		10	V	
Output Voltages	V _{HDRV} to V _{SW}	-0.3	10	V	
	V _{BST} to V _{SW}	-0.3	10		
7	V _{SW} to GND	-3	V _{IN} +0.3		
Temperature	Operating junction temperature range, T _J	-40	+125	°C	

7.4 Thermal Information(Note 4)

Symbol	Description	ETSSOP-20	Unit
θ _{JA}	Junction to ambient thermal resistance	40	°C/W
θјс	Junction to case thermal resistance	23	C/VV



- Notes:
 1) Exceeding these ratings may damage the device.
 2) The device function is not guaranteed outside of the recommended operating conditions.
 3) Measured on approximately 1" square of 1 oz copper



7.5 Electrical Characteristics(Typical at Vin = 48V, T_J=25°C, unless otherwise noted.)

SYMBOL	PARAMETER	CONDITION	MIN	TYP	MAX	UNIT	
VIN	Input Supply Operating Voltage Range		12		100		
VOUT	Regulated Output Voltage Set Point		1.2		60		
REFEREN	CE VOLTAGE						
IQ	Statics Current	Open Loop, VFB = 1.25V, No Switching, VIN=48V , TJ=25℃		400		uA	
Ishutdown	EN Shutdown Supply Current	Close Loop, VEN=0V, VIN=48V		20	• (
REFEREN	CE VOLTAGE				<u> </u>		
	Feedback Voltage			1.2		V	
V_{FB}	Accuracy		-1.5		+1.5	%	
CLIDDI V V	OLTAGE (VDD)		1.0		11.0	/*	
V _{DD}	V _{DD} Regulator Output	Supply by NDRV LDO Supply by EXTVCC LDO	9 9.5	9.5	10 10.5	V	
UNDERVO	LTAGE LOCKOUT						
$V_{\text{DD_UVLO}}$	V _{DD} Under Voltage Lockout Voltage(V _{DD} increasing)	-40°C≤ T _J ≤ 125°C		8		V	
V_{DD_UVLOH}	V _{DD} Under Voltage Hysteresis			670		mV	
V _{BST_UVLO}	V _{BST} Under Voltage Lockout Voltage(V _{BST} increasing)	-40°C≤ T _J ≤ 125°C		5.6		V	
V _{BST_UVLO}	V _{BST} Under Voltage Hysteresis			860		mV	
V _{IN_UVLO}	VIN Under Voltage Lockout Voltage(V _{IN} increasing)			6.5		V	
V _{IN_UVLOH}	VIN Under Voltage Hysteresis			650		mV	
$V_{\text{EN_UVLO}}$	EN Under Voltage Lockout Voltage(V _{EN} increasing)			1.2		V	
V _{EN_UVLOH}	EN Under Voltage Hysteresis			200		mV	
OVER VOL	TAGE LOCKOUT						
REF _{IN_OVP}	Reference of VIN Over Voltage Lockout Voltage(V _{IN} increasing)	,		1.2		V	
HYS _{IN_OVP}	Reference Hysteresis of VIN Over Voltage Lockout Voltage			200		mV	
CONTROL	LOOP						
I(Source/ Sink)	Source/Sink Current			300		uA	
gm	Trans-conductance			3		mS	
SOFT-STA	ART		•				
Iss	Soft-Start Current	SS = 0 V	15	20	25	uA	
VSNS LIMI	Т	•	•				
Vocset	OCSET voltage	-40°C≤ T _J ≤ 125°C		1.2		V	
VLIMH	On Duty ISNS1-ISNS2 Limit	R _{OCSET} = 25k Ohm, VLIMH=1.2/R _{OCSET} *25K/10		120		mV	
VLIML	Off Duty ISNS1-ISNS2 Limit	R _{OCSET} = 25k Ohm, VLIML=1.2/R _{OCSET} *20K/10		96		mV	
Toverload	Over Load Protection Blank Time	3332. 23.210		200		ms	
Frequency	Frequency						
F _{sw}	Switching Frequency	Fsw=Vout/(Rh*500p) or	50	200	500	kHz	
		Fsw=1/(RL*50p)					

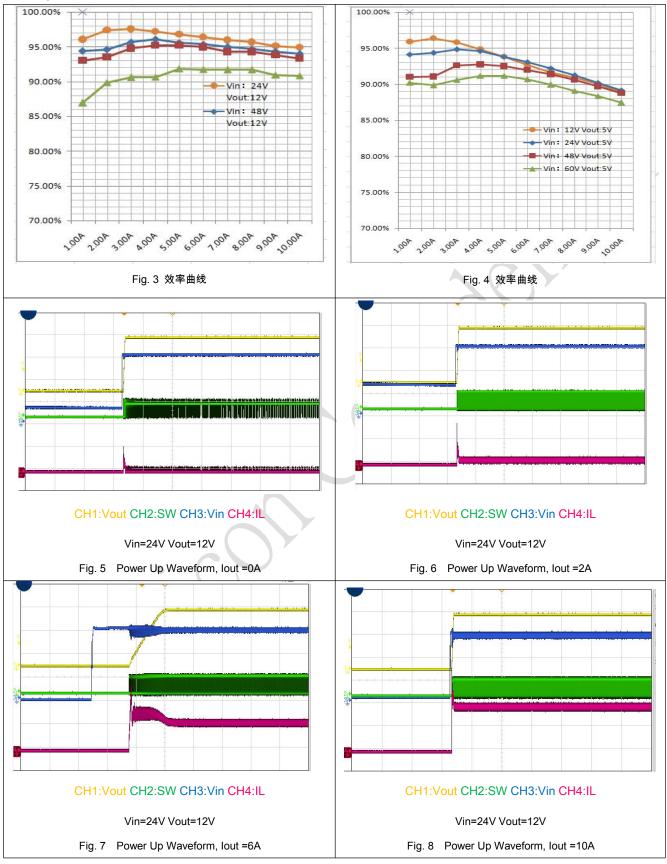


TON _{MIN}	Minimum On Time			140	ns
TOFF _{MIN}	Minimum Off Time			400	ns
Toff Timer					
		Toff = GND		0	s
T_{OFF}	Toff Time Delay	Toff = Float		10	s
		Toff = VDD		20	s
OUTPUT D	DRIVERS		•		
LIDDV	Peak HDRV Source Current			1	Α
HDRV	Peak HDRV Sink Current			2.2	Α
LDD\/	Peak LDRV Source Current			1.8	Α
LDRV	Peak LDRV Sink Current			3.5	Α
Tr(HDRV)	CLOAD = 1000pF			19	ns
Tf(HDRV)	CLOAD = 1000pF			13	ns
Tr(LDRV)	CLOAD = 1000pF			18	ns
Tf(LDRV)	CLOAD = 1000pF			12	ns
Tdelay1	Top Gate Off to Bottom Gate On Delay			70	ns
Tdelay2	Bottom Gate Off to Top Gate On Delay		CA	70	ns

Note:4) Guaranteed by design, not tested in production.



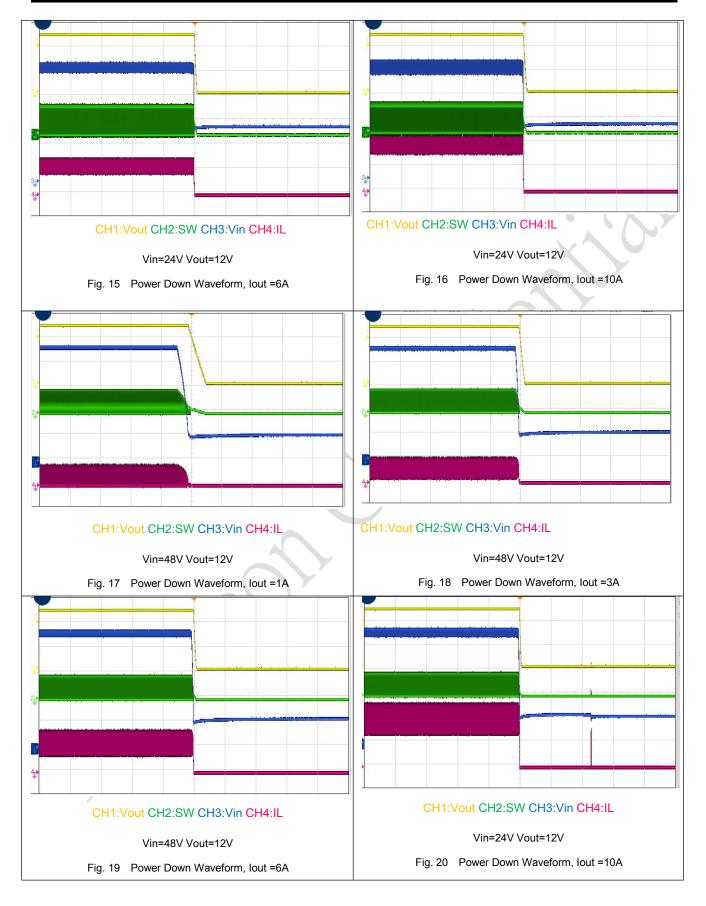
7.6 Typical Characteristics













8 Detailed Description

8.1 Overview

The PL59011 is a high voltage PWM controller designed for high performance synchronous Buck DC/DC applications with input voltages up to 100V. The PL59011 adopts adaptive constant on time peak current mode control at the moderate to heavy load currents and operates in the PFM mode at the light load current. With this control scheme, the PL59011 provides the excellent line and load transient response with the minimal output capacitor. The external loop compensation brings the flexibility to use a wider range of the inductor and output capacitor combinations.

The PL59011 supports the adjustable switching frequency up to 500kHz. This device implements user programmable cycle-by-cycle current limit with 200ms over load timer to protect the device from thermal run away. If the overload condition is triggered, this part will stop switching until EN is toggled. This device also implements user programmable over voltage lockout protection and over temperature protection to ensure reliably operation.

8.2 Functional Block Diagram

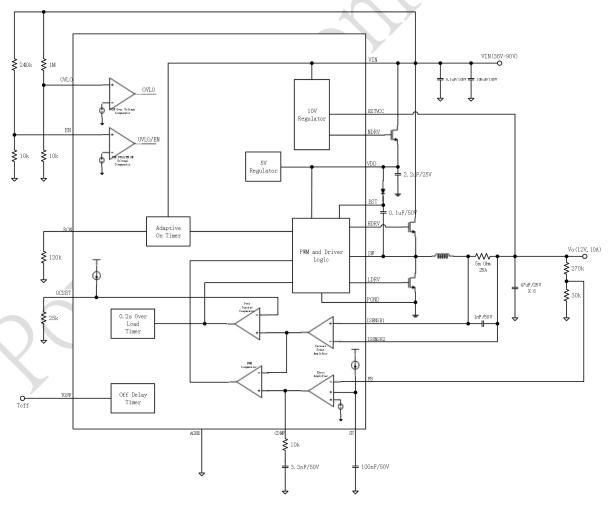


Fig. 21 Functional Block Diagram



8.3 Feature Description

8.3.1 Enable and OVLO

When the EN pin is pulled high above 1.2V, this part is enabled. When the EN pin is pulled below 1.0V, this part goes into the shutdown mode and stops operation.

When the OVLO pin is pulled high above 1.2V, the PL59011 is disabled and it will not resume switching even if OVLO falls below 1.0V unless EN is toggled.

8.3.2 Under-voltage Lockout

This controller stops switching when the input voltage drops below 5.85V or VDD is below 7.33V. It resumes operation when input voltage is larger than 6.5V and VDD is larger than 8V.

8.3.3 Cycle-by-Cycle Current Limit and Over Load Protection

The PL59011 provides cycle-by-cycle current limit to protect power MOSFET during on duty and also off duty. It will immediately turn off high side MOSFET once on duty current limit is triggered or prolongs the off duty until the inductor current is lower than off duty current limit. Hiccup protection will be triggered if the over current condition endures more than 200ms. And the switching will be resumed after 16 soft start procedures.

8.3.4 Programmable Switching Frequency

This controller features a programmable switching frequency ranging from 50kHz to 500kHz.

The frequency setting by RON is calculated as below:

$$F_{SW} = \frac{V_{OUT}}{R_{ON}(k\Omega) \times 0.5} (MHz)$$
 (1)

8.3.5 Error Amplifier

The PL59011 has a trans-conductance amplifier and compares the feedback voltage with the internal voltage reference (or the internal soft start voltage during startup phase). The trans-conductance of the error amplifier is 3 mA / V typically. The loop compensation components are required to be placed between the COMP terminal and ground to balance the loop stability and the transient response time.

8.3.6 VDD Regulators

The PL59011 contains two VDD regulators that provide power supply for low side gate driver and boot-strap high side gate drive. One is the NDRV regulator which regulates VDD to 9.5V. The other one is the 10V low dropout LDO powered by EXTVCC which is current limited to 60mA. The VDD load current should be evaluated if NDRV regulator is not used.

8.3.7 Bootstrap Voltage (BST)

The PL59011 has an integrated bootstrap regulator, and requires a small ceramic capacitor between the BST pin and SW pin to provide the gate drive voltage for the high-side FET. The bootstrap capacitor is charged when the BST-SW voltage is below regulation. The value of this ceramic capacitor should be above 100 nF. A ceramic capacitor with an X7R or X5R grade dielectric with a voltage rating of 25 V or higher is recommended because of the stable characteristics over temperature and DC biased voltage.



8.3.8 Thermal Shutdown

A thermal shutdown is implemented to prevent the damage due to the excessive heat and power dissipation. Typically, the thermal shutdown occurs at the junction temperature exceeding 150°C. When the thermal shutdown is triggered, the device stops switching and recover when the junction temperature falls below 130°C.



9 Application and Implementation

9.1 Setting the switching Frequency

The switching frequency of the PL59011 can be programmed as equation 1. For a target switching frequency of 200 kHz, The calculated value is 120 k Ω .

9.2 Setting the Output Current Limit

The cycle-by-cycle current limit of the PL59011 is configured by combination of Rocset between OCSET and AGND and sense resistor Rsns in serial with inductor. The cycle-by-cycle current limit is determined as follows:

$$I_{LIML} = \frac{2.4}{R_{OCSET}(k\Omega) \times R_{SNS}(\Omega)} (A)$$
 (2)

9.3 Setting the Output Voltage

Choose R1 and R2 to program the proper output voltage. To minimize the power consumption under light load, it is desirable to choose large resistance values for both R1 and R2. A value between 10k and 1M is recommended for both resistors. If R1=200k is chosen, then R2 can be calculated to be:

$$V_{OUT} = V_{FB} \times \left(1 + \frac{R_1}{R_2}\right) \tag{3}$$

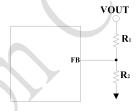


Fig. 22

9.4 Selecting the Inductor

1) Choose the inductance to provide the desired ripple current. It is suggested to choose the ripple current to be about 40% of the maximum average input current. The inductance is calculated as:

$$L = \frac{V_{OUT}}{V_{IN}} \times \frac{V_{IN} - V_{OUT}}{0.4 \times F_{SW} \times I_{OUT_MAX}}$$
 (4)

where F_{SW} is the switching frequency and $I_{OUT\ MAX}$ is the maximum load current.

PL59011 is less sensitive to the ripple current variations. Consequently, the final choice of inductance can be slightly off the calculation value without significantly impacting the performance.

- 2) The saturation current rating of an inductor must be selected to guarantee an adequate margin to the peak inductor current under full load conditions.
- 3) The DCR of the inductor and the core loss at the switching frequency must be low enough to achieve the desired efficiency requirement. It is desirable to choose an inductor with DCR<10mohm to achieve a good over -all efficiency.



9.5 Selecting the Output Capacitors

The Output capacitor is selected to handle the output ripple noise requirements. Both steady state ripple and transient requirements must be taken in to account when selecting these capacitors. For the best performance, it is recommended to use X5R or better grade ceramic capacitor.

9.6 Selecting the Input Capacitors

Multilayer ceramic capacitors are an excellent choice for the input decoupling of the step-down converter as they have extremely low ESR and are available in small footprints. Input capacitors should be located as close as possible to the device. While a 10-µF input capacitor is sufficient for the most applications, larger values may be used to reduce input current ripple.

Take care when using only ceramic input capacitors. When a ceramic capacitor is used at the input and the power is being supplied through long wires, such as from a wall adapter, a load step at the output can induce ringing at the VIN pin. This ringing can couple to the output and be mistaken as loop instability or could even damage the part. Additional "bulk" capacitance (electrolytic or tantalum) in this circumstance, should be placed between CIN and the power source lead to reduce ringing that can occur between the inductance of the power source leads and CIN.

9.7 Selecting the Bootstrap Capacitor

The bootstrap capacitor between the BST and SW pin supplies the gate current to charge the high-side FET device gate during each cycle's turn-on and also supplies charge for the bootstrap capacitor. The recommended value of the bootstrap capacitor is 0.1µF to 1µF. CBST should be a good quality, low ESR, ceramic capacitor located at the pins of the device to minimize potentially damaging voltage transients caused by trace inductance. A value of 0.1µF was selected for this design example.

9.8 Selecting the VDD Capacitors

The primary purpose of the VDD capacitor is to supply the peak transient currents of the driver and bootstrap capacitor as well as provide stability for the VDD regulator. The value of CVDD should be at least 10 times greater than the value of CBST, and should be a good quality, low ESR, ceramic capacitor. CVDD should be placed close to the pins of the IC to minimize potentially damaging voltage transients caused by the trace inductance. A value of 4.7µF was selected for this design example.

9.9 Selecting the MOSFET

Important parameters for MOSFET selection are:

- Voltage rating
- On-resistance
- · Total gate charge

The voltage rating for the high-side and low-side MOSFETs are essentially equal to the power stage input voltage VIN. A safety factor of 30% should be added to the VIN(MAX).



9.10 Example

The Figure 15 is the typical application schematic for 36 to 90-V input to output 12-Voutput converter.

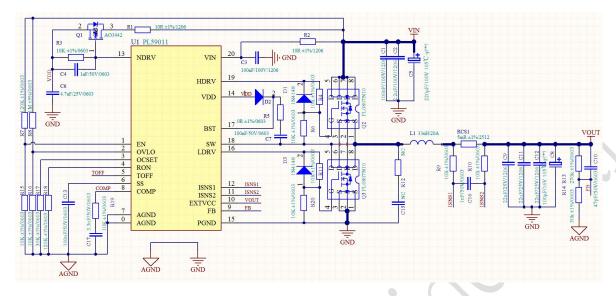


Figure 23. Application Schematic

10 PCB Layout

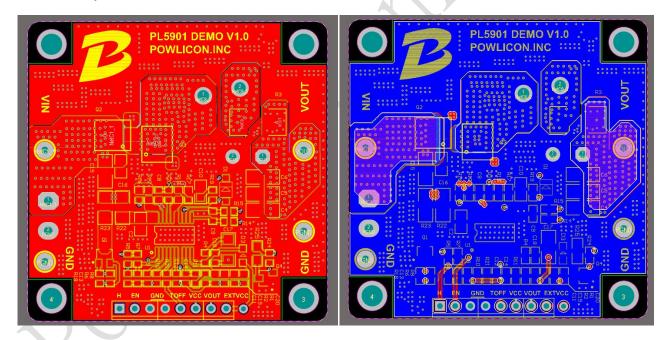


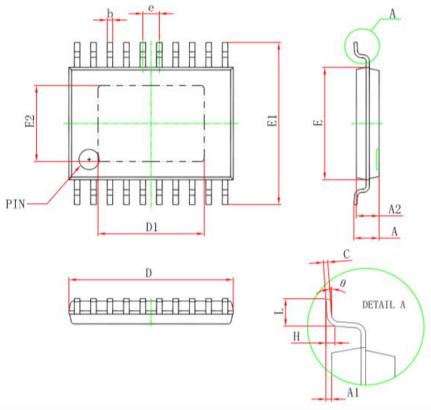
Figure 24. Top lay

Figure 25. Bottom lay



11 Packaging Information

TSSOP20/PP PACKAGE OUTLINE DIMENSIONS



C11	Dimensions I	n Millimeters	Dimension	is In Inches
Symbol	Min	Max	Min	Max
D	6. 400	6. 600	0.252	0.259
Dl	4. 100	4. 300	0.165	0.169
E	4.300	4. 500	0.169	0.177
ь	0.190	0.300	0.007	0.012
c	0.090	0. 200	0.004	0.008
El	6. 250	6. 550	0.246	0.258
E2	2.900	3.100	0.114	0.122
A		1.100		0.043
A2	0.800	1.000	0.031	0.039
A1	0.020	0.150	0.001	0.006
e	0.65	BSC)	0.026	
L	0.500	0.700	0.02 0.0	
н	0.250	TYP)	0.01(TYP)	
9	1.	7.	1.	7.



12 Version Control

版本	日期	撰写	页数	更新说明
Rev.1.1	2022-03-04	Victor	18	增加产品订购信息